

File No. W-17/9/2021-IPHW
Government of India
Ministry of Electronics and Information Technology (MeitY)
IPHW Division

Dated: 30th December, 2021

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ADDENDUM
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Amendments in Production Linked Incentive Scheme (PLI) for IT Hardware – reg.

References:

- i. *PLI Scheme Notification No. CG-DL-E-03032021-225613 dated 3st March, 2021 in Part – I, Section 1 of the Gazette of India (Extraordinary) [File No. W-18/28/2020-IPHW]*
- ii. *Guidelines for the Operation of Production Linked Incentive Scheme (PLI) for IT Hardware dated 15st April, 2021 [File No. W-18/28/2020-IPHW]*

Ministry of Electronics and Information Technology (MeitY) notified the Production Linked Incentive Scheme (PLI) for IT Hardware on March 03, 2021. Subsequently, Guidelines for the operation of the Scheme were notified on 15.04.2021. The Scheme was open for receiving applications till 30.04.2021.

2. As per Para 12.3 of the PLI Scheme, *the Empowered Group of Secretaries (EGoS) may revise incentive rates, ceilings, target segment(s) and eligibility criteria as deemed appropriate during the tenure of the Scheme.* In accordance with Para 12.3 of the Scheme, the EGoS in its meeting held on 13th December 2021 has approved the following amendment in the Para 6 of the PLI Scheme for IT Hardware notified and subsequently in Para 3.6 of the Scheme Guidelines:

S. No	Timeline	Sub-Assembly to be Localized	Criteria	Applicable Incentive
1	01.04.2021	Not Applicable		4%

2	01.04.2022 onwards	1. PCB Assembly	Assembled domestically by the applicant company itself or through one of its vendors subject to the condition that investment for PCB Assembly will be capitalized in the books of accounts of the applicant company	3%
3	01.04.2023 onwards	1. PCB Assembly	Assembled domestically by the applicant company itself or through one of its vendors subject to the condition that investment for PCB Assembly will be capitalized in the books of accounts of the applicant company	2%
		2. Battery Packs	Assembled domestically, either by the applicant company itself or through one of its vendors. <i>(not applicable for All-in-One PCs and Servers)</i>	
4	01.04.2024 onwards	1. PCB Assembly	Assembled domestically by the applicant company itself or through one of its vendors subject to the condition that investment for PCB Assembly will be capitalized in the books of accounts of the applicant company	2%
		2. Battery Packs	Assembled domestically, either by the applicant company itself or through one of its vendors. <i>(not applicable for All-in-One PCs and Servers)</i>	
		3. Power Adapters / SMPS	Assembled domestically, either by the applicant company itself or through one of its vendors.	

		4. Cabinets / Chassis / Enclosures	Assembled domestically, either by the applicant company itself or through one of its vendors.	
	OR			
01.04.2024 onwards	1. PCB Assembly	Assembled domestically by the applicant company itself or through one of its vendors subject to the condition that investment for PCB Assembly will be capitalized in the books of accounts of the applicant company		1%
	2. Battery Packs	Assembled domestically, either by the applicant company itself or through one of its vendors. <i>(not applicable for All-in-One PCs and Servers)</i>		
	3. Power Adapters / SMPS	Assembled domestically, either by the applicant company itself or through one of its vendors.		

3. Aforesaid amendment is to be read with revised Para 4.2.4 of the Scheme Guidelines, i.e., “In such case that plant, machinery, equipment, tools, dies, moulds, jigs, fixtures and parts, accessories, components, and spares are located outside the premises of an applicant, appropriate undertaking(s) from the person having custody of these equipment / components along with valid legal agreement(s) for the said transaction(s) shall be obtained. These plant, machinery, equipment, tools, dies, moulds, jigs, fixtures and parts, accessories, components, and spares should not be located outside the country”.

4. Further, aforesaid amendment is to be read with revised Para 7.4 of the Scheme Guidelines, i.e., “The PMA shall have a right to carry physical inspection of an applicant’s manufacturing units and offices or vendor’s manufacturing units and offices (only for such vendors who are engaged for meeting any of the localization criteria mentioned at

Para 3.6 - Localization Schedule requirements) through site visits. It shall be the responsibility of the applicant to facilitate site visit and/ or for obtaining relevant information / documents pertaining to localization from such vendor(s)".

5. The PLI Scheme Guidelines issued on 15.04.2021 shall be read incorporating the above changes wherever applicable.

6. This aforesaid addendum is issued with the approval of Hon'ble Minister of Electronics and Information Technology.

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